

Bit-Brick SSOM-IMX9352 DATASHEET



Provisional version

V 1.0

Bit Brick Education Technology Corporation

Jun 3, 2025

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1. Product introduction

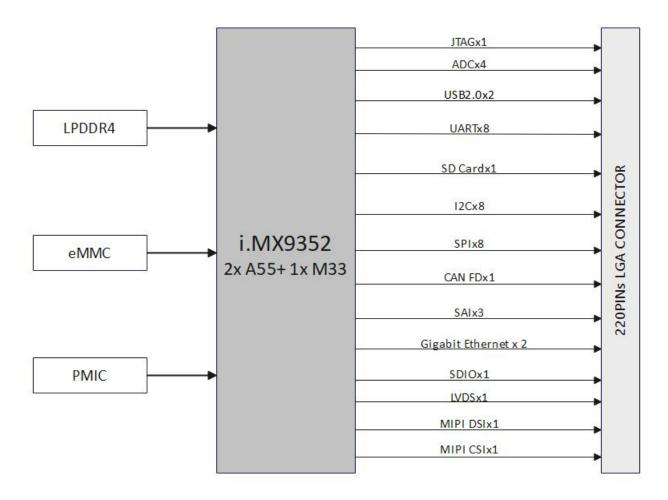
SSOM-IMX9352 is a high-performance and low-cost core module developed based on NXP's i.MX9352 processor. It integrates 2 Cortex-A55 cores and 1 Cortex-M33 real-time core, with a maximum main frequency of up to 1.7 GHz. Common interfaces such as UART, 2 Gigabit Ethernets (one of which supports TSN), USB 2.0, and CANFD are led out. A 0.5 TOPS NPU is integrated to accelerate edge machine learning applications.

SSOM-IMX9352 measures only 40x40mm, which is compact and easy to integrate into various products, providing customers with high-performance and low-cost solutions.

2. Processor Functional Block Diagram



3. Hardware Functional Block Diagram



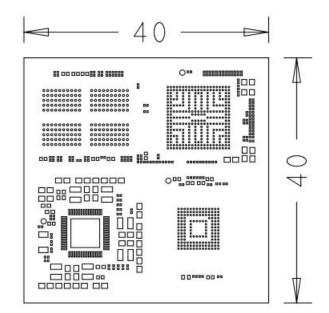


4. Specifications

Form factor	Specification		
	CPU	NXP i.MX9352, 2x Cortex-A55@1.7GHz + 1x Cortex-M33@250MHz	
	NPU	0.5 TOPS	
Processor	Vedio	Output: 1x MIPI-DSI(up to 1920x1200p60); 1x LVDS TX(up to 1366x768p60 or 1280x800p60); Input: 1x MIPI-CSI	
	Audio	3x SAI; 1x SPDIF; 1x 24bit PDM	
	Ethernet	2xGigabit Ethernet(1w/TSN)	
	RAM	1GB/2GB LPDDR4 SDRAM	
Memory	Flash	8GB/16GB eMMC	
	USB	2xUSB2.0 OTG	
	Gigabit Ethernet	2x	
	ADC	4x	
	CAN FD	1x	
	MIPI DSI	1x	
	MIPI CSI	1x	
10	LVDS	1x	
	UART	8x	
	I2C	8x	
	SAI	3x	
	SDIO	1x	
	SPI	8x	
	JTAG	1x	
Power supply	Power Supply Voltage	DC 5V	
Environment	Operating Temperature	-20 ~ +75 °C	
Environment	Operating Humidity	95% relative humidity, non-condensing	
Mechanical	Dimensions (W x D)	40.0 x 40.0mm	
Operation System		Linux	
Certifications		CE/FCC Class B	

5. Dimension Specifications

Size: 40.0mm X 40.0mm





6. Pin definations

	Outer Ring Pads		Inner Ring Pads
Pin	Pin Defination	Pin	Pin Defination
Number		Number	
1	GND1	97	PDM_CLK
2	LVDS_CLK_P	98	PDM_DATA0
3	LVDS_CLK_N	99	PDM_DATA1
4	GND2	100	GPIO_IO01
5 6	LVDS_TX0_P	101	GPIO_I000
7	LVDS_TX0_N GND3	102	GPIO_IO03 GPIO_IO02
8	LVDS_TX1_P	103	GPI0_IO02
9	LVDS_TX1_N	105	GPIO IO05
10	GND4	106	GPIO_IO06
11	LVDS_TX2_P	107	GPIO_IO07
12	LVDS_TX2_N	108	GPIO_IO12
13	GND5	109	GPI0_IO13
14	LVDS_TX3_P	110	GPI0_IO14
15	LVDS_TX3_N	111	GPIO_IO15
16	GND6	112	GPIO IO29
17	PMIC_32K_OUT	113	PMIC_nINT
18	SYS_nRST	114	NC1
19	PMIC SCLL	115	NC2
20	PMIC_SDAL	116	NC3
21	JTAG_TDO	117	NC4
22	JTAG_TDI	118	NC5
23	JTAG_TMS	119	VDD1V8 2
24	JTAG_TCK	120	 VDD5V_4
25	GND7	121	VDD5V_5
26	VDD1V8_1	122	VDD5V_6
27	VDD5V_1	123	VDD3V3_2
28	VDD5V_2	124	GND14
29	VDD5V_3	125	GND15
30	VDD3V3_1	126	GND16
31	GND8	127	CLKO04
32	GND9	128	CLKO03
33	GPIO_IO22	129	CLKO02
34	GPIO_IO23	130	CLKO01
35	GPIO_IO24	131	GND17
36	GPIO_IO28	132	ENET2_MDC
37	ENET2_TDO	133	ENET2_MDIO
38	ENET2_TD1	134	GND18
39	ENET2_TD2	135	SD3_CLK
40	ENET2_TD3	136	SD3_CMD
41	ENET2_TXC	137	SD3_DATAO
42	ENET2_TX_CTL	138	SD3_DATA1
43	ENET2_RDO	139	SD3_DATA2
44	ENET2_RD1	140	SD3_DATA3
45	ENET2_RD2	141	ENET1_MDC
46	ENET2_RD3	142	ENET1_MDIO
47	ENET2_RXC	143	GPI0_IO25
48	ENET2_RX_CTL	144	GPI0_I027
49 50	ENET1_RX_CTL	145 146	GPIO_IO16
50	ENET1_RXC	146	GPIO_IO19 GPIO_IO20
51	ENET1_RD3 ENET1 RD2	147	GPIO_IO20 GPIO_IO26
53	ENETT RD2 ENET1_RD1	148	GPIO_IO26 GPIO_IO17
53 54	ENET1_RD0	150	GPIO_IO17 GPIO_IO08
55	ENETT RDO ENETT_TX_CTL	150	GPIO_IO08 GPIO_IO09
56	ENET1_TX_CTL ENET1_TXC	152	GPIO_IO09 GPIO_IO10
57	ENET1_TAG ENET1 TD3	153	GPIO_IO10 GPIO_IO11
31	LINLTTIDO	133	GFIO_IOTI



58	ENET1 TD2	154	SAI1_RXDO	
59	ENET1 TD1	155	SAI1_TXDO	
60			SAI1_TXC	
61	SD2_DATA3	157	SAI1_TXFS	
62	SD2_DATA2	158	WDOG_B	
63	SD2_DATA1	159	UART2_TXD	
64	SD2_DATA0	160	UART2_RXD	
65	SD2_nRST	161	UART1_RXD	
66	SD2_CLK	162	UART1_TXD	
67	SD2 CMD	163	ADC_IN3	
68	SD2_nCD	164	ADC_IN1	
69	SD2_VSEL	165	ADC_IN2	
70	NVCC_SD	166	ADC_INO	
71	ONOFF	167	PMIC_STBY_REQ	
72	POR_B	168	PMIC_ON_REQ	
73	GND10			
74	USB2_DN	170	CLKIN2	
75	USB2_DP	171	USB1_ID	
76	GND11	172	USB2_ID	
77	USB1_DN	173	I2C1_SCL	
78	USB1_DP	174	 I2C1_SDA	
79	GND12	175	12C2_SCL	
80	CSI_CLK_P	176	12C2_SDA	
81	CSI_CLK_N	177	USB_PWRON	
82	CSI_DO_P	178	GND19	
83	CSI_DO_N	179	TAMPERO	
84	CSI_D1_P	180	TAMPER1	
85	CSI_D1_N	181	NVCC_BBSM_1V8	
86	GND13	182	GPIO_IO21	
87	DSI_D3_N	183	GPIO_IO18	
88	DSI_D3_P	184	GND20	
89	DSI_D2_N			
90	DSI_D2_P			
91	DSI_D1_N			
92	DSI_D1_P			
93	DSI_DO_N			
94	DSI_DO_P			
95	DSI_CLK_N			
96	DSI_CLK_P			

Central Pads		
Pin Number	Pin Defination	
185	GND23	
186	GND24	
187	GND25	
188	GND26	
189	GND27	
190	GND38	
191	GND39	
192	GND40	
193	GND41	
194	GND42	
195	GND43	
196	GND44	
197	GND45	
198	GND46	
199	GND47	
200	GND48	
201	GND49	
202	GND50	



203	GND51
204	GND52
205	GND53
206	GND54
207	GND55
208	GND56
209	GND57
210	GND58
211	GND59
212	GND60
213	GND61
214	GND62
215	GND63
216	GND64
217	GND65
218	GND66
219	GND67
220	GND68

7. Ordering Information

Part No.	СРИ	Memory	Flash	Operating Temperature
SSOM-IMX9352-0108	i.MX9352	1GB	8GB	-20~75°C
SSOM-IMX9352-0216	i.MX9352	2GB	16GB	-20~75°C

8. Update History

Version Revision	Update Date	Content
Provisional V 1.0	2025-6-3	Initial the first version